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www.vishay.com

VS-GB150LH120N

Vishay Semiconductors

Molding Type Module IGBT, Chopper in 1 Package, 1200 V and 150 A



Double INT-A-PAK

FEATURES

- High short circuit capability, self limiting to 6 x I_C
- 10 μs short circuit capability
- V_{CE(on)} with positive temperature coefficient
- Maximum junction temperature 150 °C
- Low inductance case
- Fast and soft reverse recovery antiparallel FWD
- Isolated copper baseplate using DCB (Direct Copper Bonding) technology
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT

PRODUCT SUMMARY	
V _{CES}	1200 V
I _C at T _C = 80 °C	150 A
V _{CE(on)} (typical) at I _C = 150 A, 25 °C	1.87 V
Speed	8 kHz to 30 kHz
Package	Double INT-A-PAK
Circuit	Chopper low side switch

TYPICAL APPLICATIONS

- AC inverter drives
- Switching mode power supplies
- Electronic welders

DESCRIPTION

Vishay's IGBT power module provides ultra low conduction loss as well as short circuit ruggedness. It is designed for applications such as general inverters and UPS.

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS
Collector to emitter voltage	V _{CES}		1200	V
Gate to emitter voltage	V _{GES}		± 20	
Collector current	I _C	T _C = 25 °C	300	A
		T _C = 80 °C	150	
Pulsed collector current	I _{CM} ⁽¹⁾	t _p = 1 ms	300	
Diode continuous forward current	I _F	T _C = 80 °C	150	
Diode maximum forward current	I _{FM}	t _p = 1 ms	300	
Maximum power dissipation	P _D	T _J = 150 °C	1389	
Short circuit withstand time	t _{SC}	T _J = 125 °C	10	μs
RMS isolation voltage	V _{ISOL}	f = 50 Hz, t = 1 min	2500	V
I ² t-value, diode	I ² t	V _R = 0 V, t = 10 ms, T _J = 125 °C	4800	A ² s

Note

(1) Repetitive rating: pulse width limited by maximum junction temperature.



IGBT ELECTRICAL SPECIFICATIONS (T _C = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Collector to emitter breakdown voltage	V _{(BR)CES}	T _J = 25 °C	1200	-	-	V
Collector to emitter voltage	V _{CE(on)}	V _{GE} = 15 V, I _C = 150 A, T _J = 25 °C	-	1.87	-	
		V _{GE} = 15 V, I _C = 150 A, T _J = 125 °C	-	2.08	-	
Gate to emitter threshold voltage	V _{GE(th)}	V _{CE} = V _{GE} , I _C = 12.0 mA, T _J = 25 °C	5.0	6.3	7.0	
Collector cut-off current	I _{CES}	V _{CE} = V _{CES} , V _{GE} = 0 V, T _J = 25 °C	-	-	1.0	mA
Gate to emitter leakage current	I _{GES}	V _{GE} = V _{GES} , V _{CE} = 0 V, T _J = 25 °C	-	-	400	nA

SWITCHING CHARACTERISTICS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Turn-on delay time	t _{d(on)}	V _{CC} = 600 V, I _C = 150 A, R _g = 6.8 Ω, V _{GE} = ± 15 V, T _J = 25 °C	-	190	-	ns
Rise time	t _r		-	60	-	
Turn-off delay time	t _{d(off)}		-	460	-	
Fall time	t _f		-	55	-	mJ
Turn-on switching loss	E _{on}		-	11.2	-	
Turn-off switching loss	E _{off}	-	9.8	-	ns	
Turn-on delay time	t _{d(on)}	V _{CC} = 600 V, I _C = 150 A, R _g = 6.8 Ω, V _{GE} = ± 15 V, T _J = 125 °C	-	220		-
Rise time	t _r		-	60		-
Turn-off delay time	t _{d(off)}		-	530		-
Fall time	t _f		-	75		-
Turn-on switching loss	E _{on}		-	16.7	-	mJ
Turn-off switching loss	E _{off}	-	15.3	-		
Input capacitance	C _{ies}	V _{GE} = 0 V, V _{CE} = 25 V, f = 1.0 MHz	-	10.6	-	nF
Output capacitance	C _{oes}		-	0.71	-	
Reverse transfer capacitance	C _{res}		-	0.47	-	
SC data	I _{SC}	t _{sc} ≤ 10 μs, V _{GE} = 15 V, T _J = 125 °C, V _{CC} = 900 V, V _{CEM} ≤ 1200 V	-	650	-	A
Internal gate resistance	R _{gint}		-	1.5	-	Ω
Stray inductance	L _{CE}		-	-	20	nH
Module lead resistance, terminal to chip	R _{CC'+EE'}	T _C = 25 °C	-	0.35	-	mΩ

DIODE ELECTRICAL SPECIFICATIONS (T _C = 25 °C unless otherwise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Diode forward voltage	V _F	I _F = 150 A	T _J = 25 °C	-	2.05	-	V
			T _J = 125 °C	-	2.26	-	
Diode reverse recovery charge	Q _{rr}	I _F = 150 A, V _R = 600 V, dI/dt = -4800 A/μs, V _{GE} = -15 V	T _J = 25 °C	-	7	-	μC
			T _J = 125 °C	-	18	-	
Diode peak reverse recovery current	I _{rr}	I _F = 150 A, V _R = 600 V, dI/dt = -4800 A/μs, V _{GE} = -15 V	T _J = 25 °C	-	150	-	A
			T _J = 125 °C	-	190	-	
Diode reverse recovery energy	E _{rec}	I _F = 150 A, V _R = 600 V, dI/dt = -4800 A/μs, V _{GE} = -15 V	T _J = 25 °C	-	4.0	-	mJ
			T _J = 125 °C	-	8.0	-	



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THERMAL AND MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Operating junction temperature range	T_J		-40	-	150	$^{\circ}\text{C}$
Storage temperature range	T_{STG}		-40	-	125	$^{\circ}\text{C}$
Junction to case IGBT (per 1/2 module) Diode (per 1/2 module)	R_{thJC}		-	-	0.09	K/W
			-	-	0.24	
Case to sink	R_{thCS}	Conductive grease applied	-	0.035	-	
Mounting torque		Power terminal screw: M6	2.5 to 5.0			Nm
		Mounting screw: M6	3.0 to 6.0			
Weight			300			g

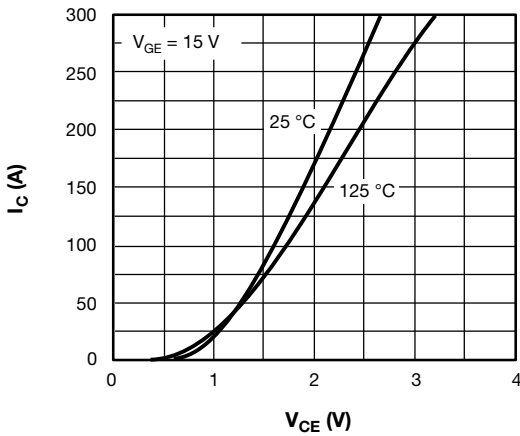


Fig. 1 - Typical Output Characteristics

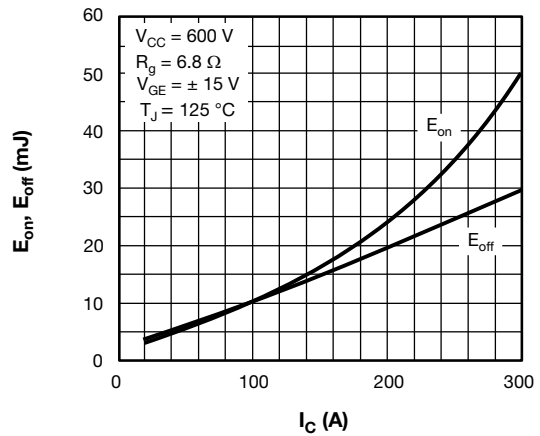


Fig. 3 - Switching Loss vs. Collector Current

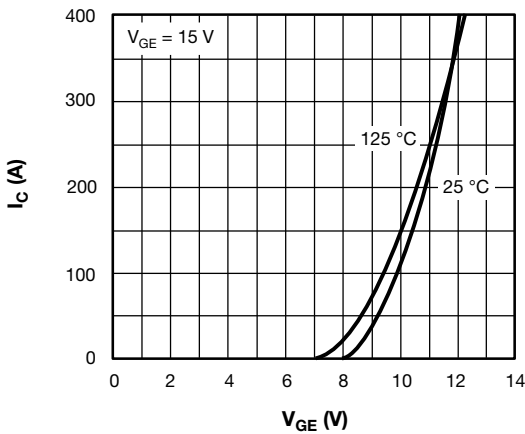


Fig. 2 - Typical Transfer Characteristics

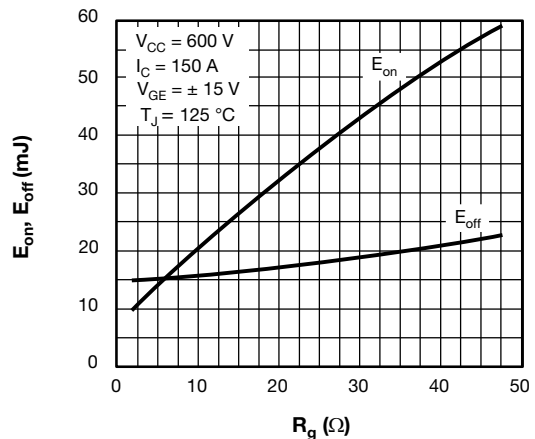


Fig. 4 - Switching Loss vs. gate Resistor



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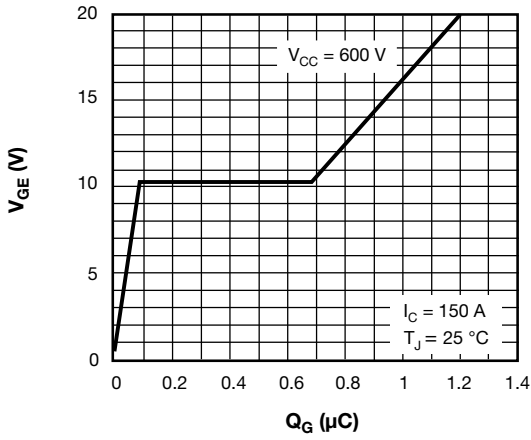


Fig. 5 - Gate Charge Characteristics

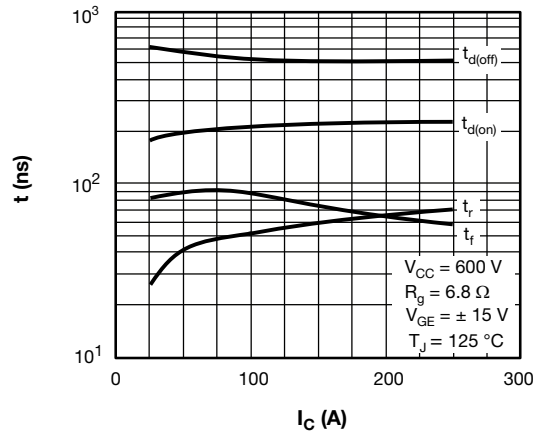


Fig. 7 - Typical Switching Times vs. I_C

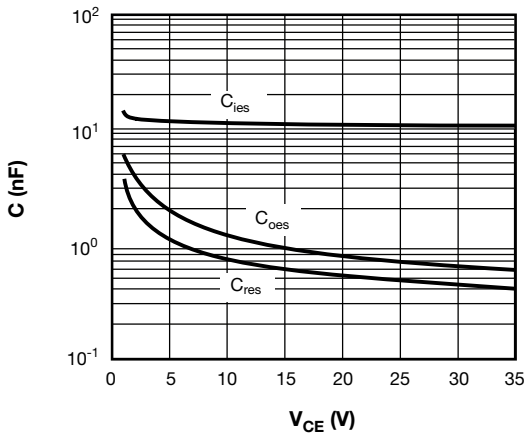


Fig. 6 - Typical Capacitance vs. Collector to Emitter Voltage

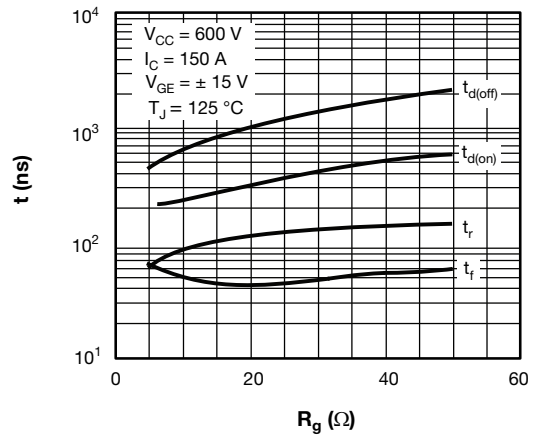


Fig. 8 - Typical Switching Times vs. Gate Resistance R_g

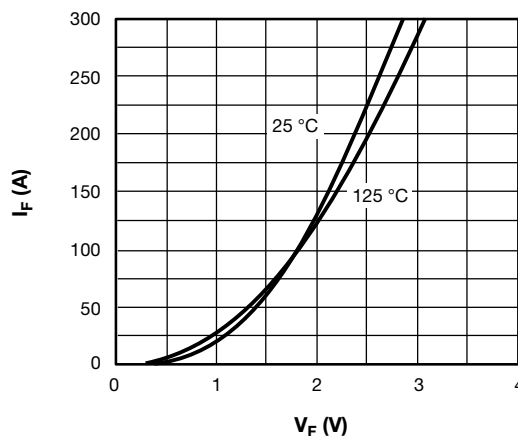


Fig. 9 - Typical Forward Characteristics, Diode



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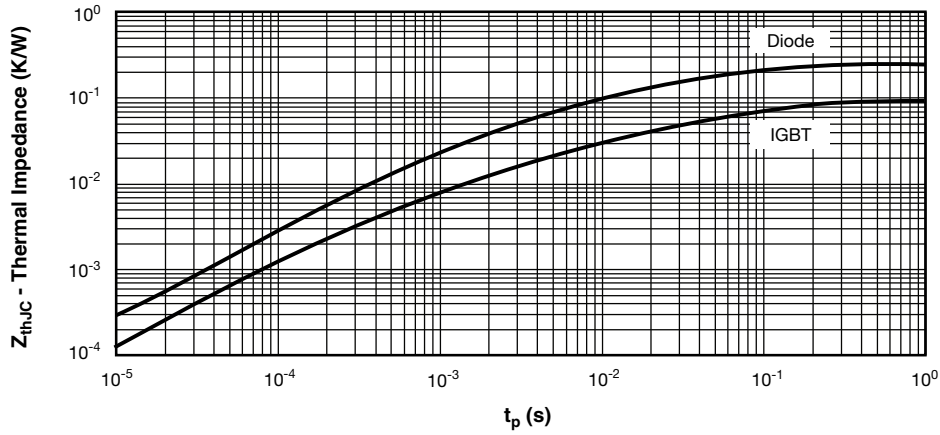
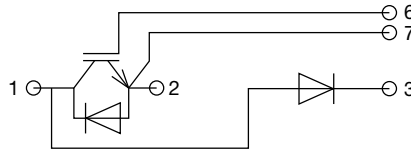


Fig. 10 - Transient Thermal Impedance

CIRCUIT CONFIGURATION



LINKS TO RELATED DOCUMENTS

Dimensions	www.vishay.com/doc?95525
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